# IRFY140 IRFY140M

# POWER MOSFET THRU-HOLE (TO-257AA)

100V, N-CHANNEL HEXFET® MOSFET TECHNOLOGY

**Product Summary** 

Part Number	RDS(on)	I <sub>D</sub>	Eyelets
IRFY140	0.077Ω	16A*	Glass
IRFY140M	0.077Ω	16A*	Glass



## **Description**

HEXFET® MOSFET technology is the key to IR Hirel advanced line of power MOSFET transistors. The efficient geometry design achieves very low on-state resistance combined with high trans conductance. HEXFET® transistors also feature all of the well-established advantages of MOSFETs, such as voltage control, very fast switching and electrical parameter temperature stability. They are well-suited for applications such as switching power supplies, motor controls, inverters, choppers, audio amplifiers, high energy pulse circuits, and virtually any application where high reliability is required. The HEXFET transistor's totally isolated package eliminates the need for additional isolating material between the device and the heatsink. This improves thermal efficiency and reduces drain capacitance.

#### **Features**

- Simple Drive Requirements
- · Hermetically Sealed
- · Electrically Isolated
- Glass Eyelets
- For Space Level Applications Refer to Ceramic Version Part Numbers IRFY140C, IRFY140CM
- ESD Rating: Class 2 per MIL-STD-750, Method 1020

## **Absolute Maximum Ratings**

Symbol	Parameter	Value	Units
$I_{D1}$ @ $V_{GS}$ = 10V, $T_{C}$ = 25°C	Continuous Drain Current	16*	
I <sub>D2</sub> @ V <sub>GS</sub> = 10V, T <sub>C</sub> = 100°C	Continuous Drain Current	16*	Α
I <sub>DM</sub> @T <sub>C</sub> = 25°C	Pulsed Drain Current ①	64	
P <sub>D</sub> @T <sub>C</sub> = 25°C	Maximum Power Dissipation	100	W
	Linear Derating Factor	0.8	W/°C
$V_{GS}$	Gate-to-Source Voltage	± 20	V
E <sub>AS</sub>	Single Pulse Avalanche Energy ②	230	mJ
I <sub>AR</sub>	Avalanche Current ①	16*	Α
E <sub>AR</sub>	Repetitive Avalanche Energy ①	10	mJ
dv/dt	Peak Diode Recovery 3	5.5	V/ns
T <sub>J</sub>	Operating Junction and	-55 to + 150	°C
T <sub>STG</sub>	Storage Temperature Range	-95 (0 + 150	
	Lead Temperature	300(0.063in./1.6mm from case for 10 sec)	
	Weight	3.3 (Typical)	g

<sup>\*</sup>Current is limited by package For footnotes refer to the page 2.



# Electrical Characteristics @ Tj = 25°C (Unless Otherwise Specified)

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions	
BV <sub>DSS</sub>	Drain-to-Source Breakdown Voltage	100			V	$V_{GS} = 0V, I_{D} = 1.0mA$	
$\Delta BV_{DSS}/\Delta T_{J}$	Breakdown Voltage Temp. Coefficient		0.1		V/°C	Reference to 25°C, I <sub>D</sub> = 1.0mA	
R <sub>DS(on)</sub>	Static Drain-to-Source On-Resistance			0.077	Ω	V <sub>GS</sub> = 10V, I <sub>D2</sub> = 16A ④	
$V_{GS(th)}$	Gate Threshold Voltage	2.0		4.0	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Gfs	Forward Transconductance	9.1			S	V <sub>DS</sub> = 15V, I <sub>D2</sub> = 16A ④	
I <sub>DSS</sub>	Zara Cata Valtaga Drain Current			25		$V_{DS} = 80V, V_{GS} = 0V$	
	Zero Gate Voltage Drain Current			250	μA	$V_{DS} = 80V, V_{GS} = 0V, T_{J} = 125^{\circ}C$	
$I_{GSS}$	Gate-to-Source Leakage Forward			100	nA	$V_{GS} = 20V$	
	Gate-to-Source Leakage Reverse			-100	ш	V <sub>GS</sub> = -20V	
$Q_G$	Total Gate Charge			59		I <sub>D1</sub> = 16A	
$Q_{GS}$	Gate-to-Source Charge			12	nC	V <sub>DS</sub> = 50V	
$Q_{GD}$	Gate-to-Drain ('Miller') Charge			30.7		V <sub>GS</sub> = 10V	
t <sub>d(on)</sub>	Turn-On Delay Time			21		V <sub>DD</sub> = 50V	
tr	Rise Time			145	ne	I <sub>D1</sub> = 16A	
t <sub>d(off)</sub>	Turn-Off Delay Time			64	ns	$R_G = 9.1\Omega$	
t <sub>f</sub>	Fall Time			105		V <sub>GS</sub> = 10V	
Ls +L <sub>D</sub>	Total Inductance		6.8		nH	Measured from drain lead (6mm/0.25in. from package) to source lead (6mm/0.25in. from package)	
C <sub>iss</sub>	Input Capacitance		1660			V <sub>GS</sub> = 0V	
Coss	Output Capacitance		550		pF	V <sub>DS</sub> = 25V	
C <sub>rss</sub>	Reverse Transfer Capacitance		120			f = 1.0 MHz	

**Source-Drain Diode Ratings and Characteristics** 

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
I <sub>S</sub>	Continuous Source Current (Body Diode)			16	۸	
I <sub>SM</sub>	Pulsed Source Current (Body Diode) ①			100	Α	
$V_{SD}$	Diode Forward Voltage			1.5	V	$T_J = 25^{\circ}C, I_S = 16A, V_{GS} = 0V$
t <sub>rr</sub>	Reverse Recovery Time			400	ns	$T_J = 25^{\circ}C, I_F = 16A, V_{DD} \le 50V$
Q <sub>rr</sub>	Reverse Recovery Charge			2.4	μC	di/dt = 100A/µs ④
Ton	Forward Turn-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by L <sub>S</sub> +L <sub>D</sub> )				

## **Thermal Resistance**

Symbol	Parameter	Min.	Тур.	Max.	Units
$R_{\theta JC}$	Junction-to-Case			1.25	
$R_{\theta CS}$	Case-to-sink		0.21		°C/W
$R_{\theta JA}$	Junction-to-Ambient (Typical Socket Mount)			80	

#### Footnotes:

- ① Repetitive Rating; Pulse width limited by maximum junction temperature.
- $^{\circ}$  V<sub>DD</sub> = 25V, starting T<sub>J</sub> = 25°C, L = 1.8mH, Peak I<sub>L</sub> = 16A, V<sub>GS</sub> = 10V.
- $\label{eq:local_sd} \mbox{$\Im$} \quad I_{SD} \ \leq 16A, \ di/dt \ \leq \ 170A/\mu s, \ V_{DD} \leq 100V, \ T_J \leq 150^{\circ}C.$

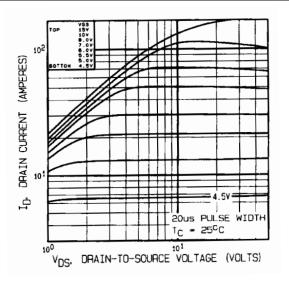


Fig 1. Typical Output Characteristics

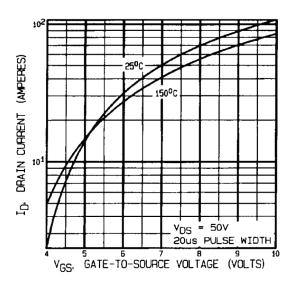


Fig 3. Typical Transfer Characteristics

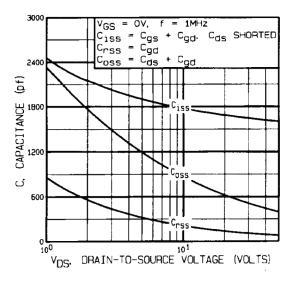


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

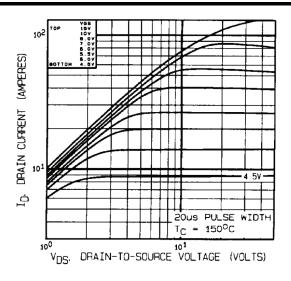


Fig 2. Typical Output Characteristics

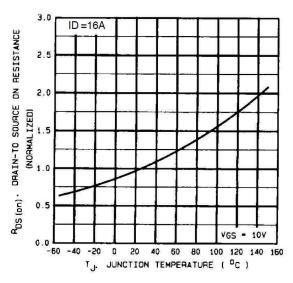


Fig 4. Normalized On-Resistance Vs. Temperature

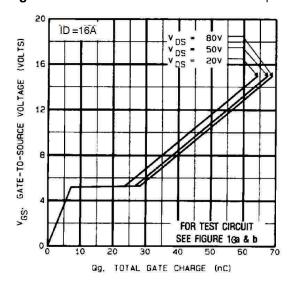


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

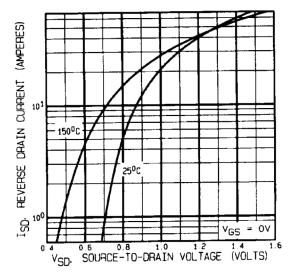


Fig 7. Typical Source-Drain Diode Forward Voltage

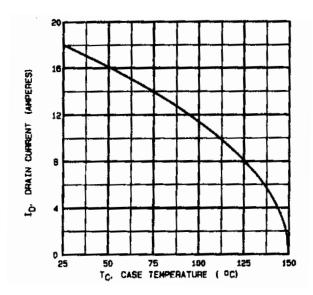


Fig 9. Maximum Drain Current Vs.Case Temperature

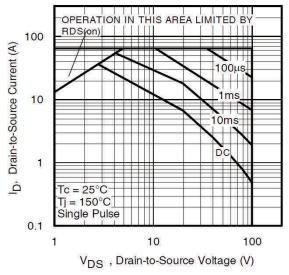
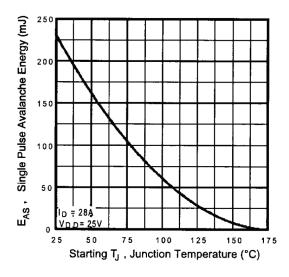


Fig 8. Maximum Safe Operating Area



**Fig 10.** Maximum Avalanche Energy Vs. Drain Current

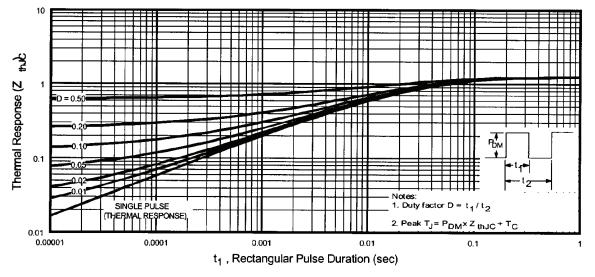


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

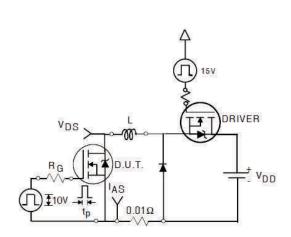


Fig 12a. Unclamped Inductive Test Circuit

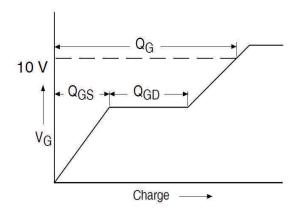


Fig 13a. Gate Charge Waveform

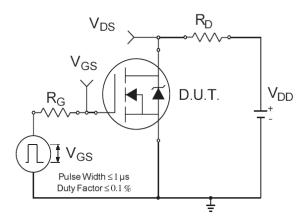


Fig 14a. Switching Time Test Circuit

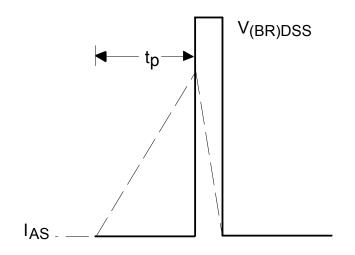


Fig 12b. Unclamped Inductive Waveforms

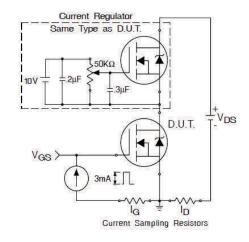


Fig 13b. Gate Charge Test Circuit

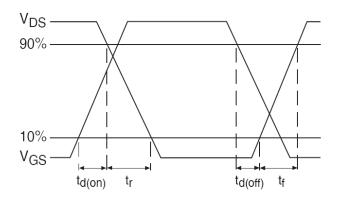
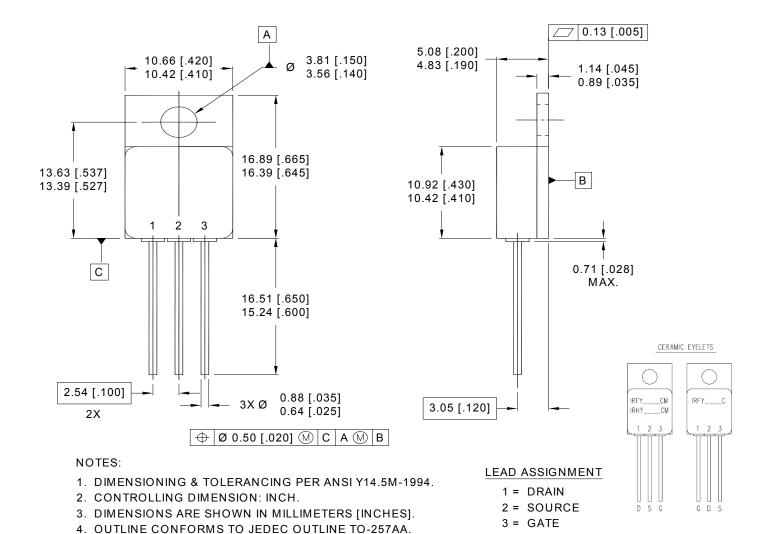


Fig 14b. Switching Time Waveforms



#### Case Outline and Dimensions - TO257AA





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